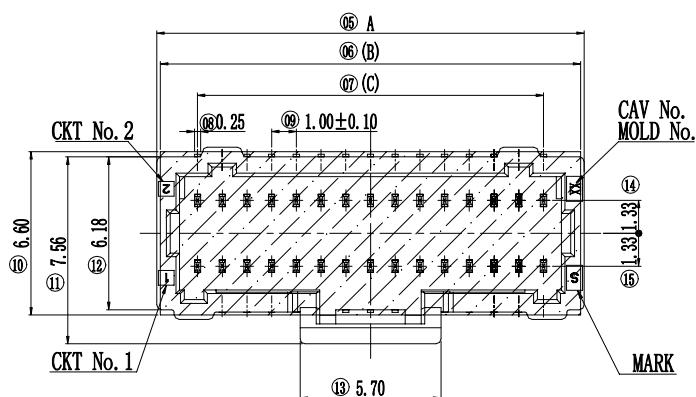
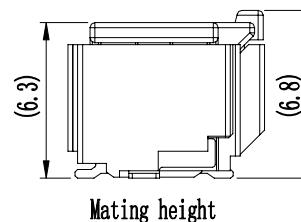
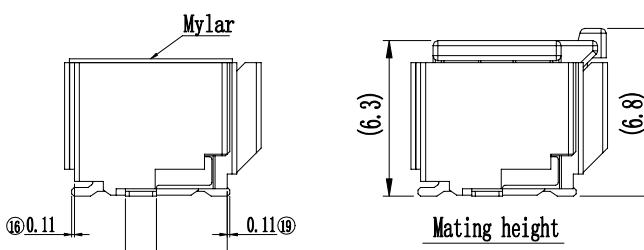
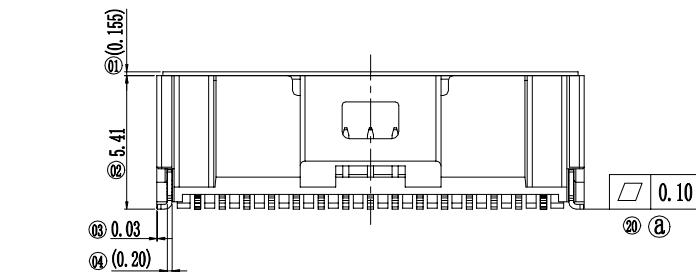
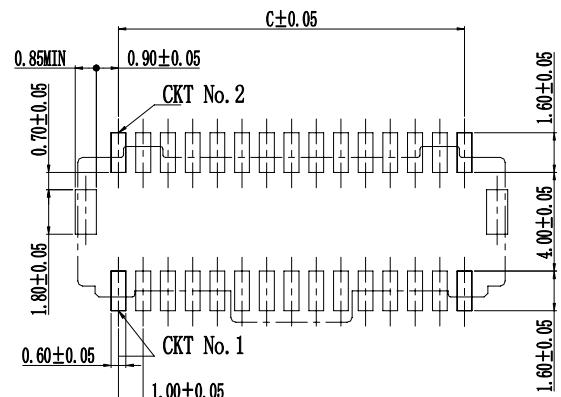


1 2 3 4 5 6 7



Terminal number	A	B	C
20P	12.3	12.0	9.00
30P	17.3	17.0	14.00
40P	22.3	22.0	19.00
50P	27.3	27.0	24.00



Recommended PCB LAYOUT
Tolerance: ± 0.05

Unless otherwise specified tolerance:

X	± 0.50	X°	$\pm 3^\circ$
.X	± 0.38	.X°	$\pm 2^\circ$
.XX	± 0.25		

Performance characteristics:

- Main body part material
Insulator: LCP Nature UL94V-0
Contact terminal: Copper alloy, 1.27 μm Ni under plated,
Contact Area plating see P/N ,
solder plating GOLDFLASH.
Solder Nail:Copper alloy,Sn plating solder Area.

2. Electrical requirements:

- Current rating: 0.5 A
- Voltage rating: 5 V
- Contact resistance: $\leq 30 \text{ m}\Omega$
- Insulation resistance: $\geq 100 \text{ M}\Omega$
- Withstanding voltage: 250 Vr.m.s, 1mA, 60s

3. Environment specification

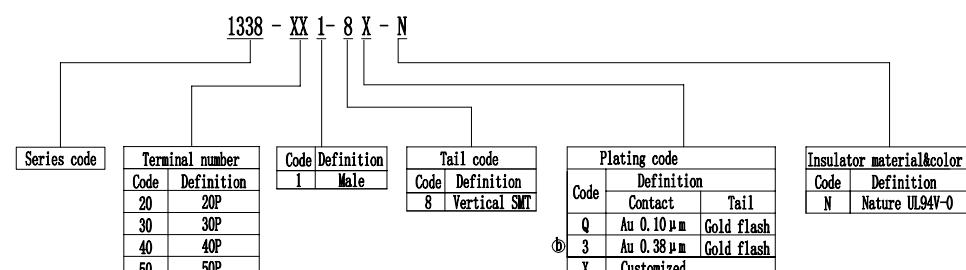
- Working temperature: -40°C ~ +105°C

4. Packing & storing

- Method of packing: Tape & reel, outer box
- Storing condition: Temperature of -10°C ~ +40°C
below 80% relative humidity

5. Style of installation: SMT

- To prevent the pollution of the environment product info
RoHS agreement: In line with the european union RoHS.



1.00mm Pitch wafer Type 1				SLO. 1338.004			
Projection	Rev.	Weight	Scale	All Dimensions in mm Sheet 1 of 1			
	A2			1338-XX1-8X-N			
				SHINNING SHENZHEN SHINNING ELECTRONIC CO.,LTD.			